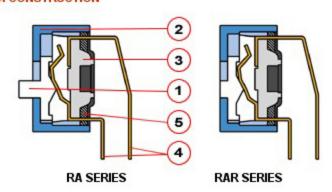


#### RA CONSTRUCTION



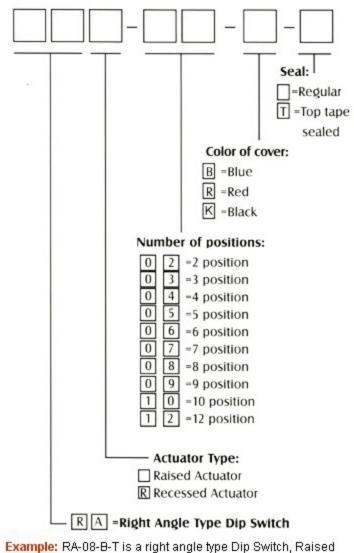
- Terminal plating by gold gives excellent results when soldering.
- RA series (raised actuator)
- Low contact resistance, and self-clean on contact area. 3.
- Double contacts offer high reliability.
- 5. All materials are UL94V-0 grade fire retardant plastics.

ITEM	Description	Materials	Treatment	
1	Actuator	UL94V-0 PBT	White	
2	Cover	UL94V-0 PBT	Blue, Red, Black	
3	Base	UL94V-0 PBT	Black	
4	Terminal	Phosphor bronze	Gold Plating	
5	Potting	Ероху	Black	

## MODEL

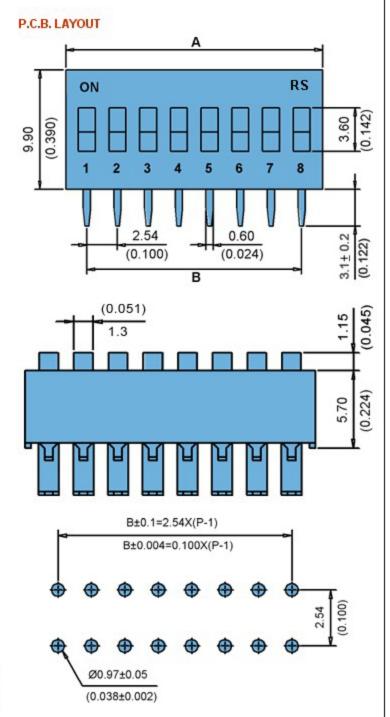
PROD NO.	NO. OF POS	DIM A	
RA/RAR-02	02	6.08	0.239
RA/RAR-03	03	8.92	0.351
RA/RAR-04	04	11.16	0.439
RA/RAR-05	05	13.70	0.539
RA/RAR-06	06	16.24	0.639
RA/RAR-07	07	19.08	0.751
RA/RAR-08	08	21.32	0.839
RA/RAR-09	09	24.16	0.951
RA/RAR-10	10	26.40	1.039
RA-RAR-12	12	31.48	1.239

## **HOW TO ORDER**

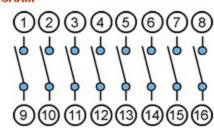


Actuator, 8 position with Top tape sealed.

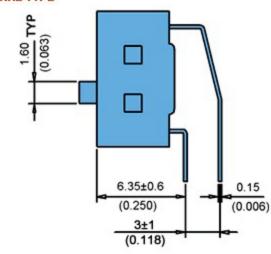
PACKING All DIP switches are shipped in standard IC tubes with all poles in "OFF" position.



#### CIRCUIT DIAGRAM



## TERMINAL TYPE



## **SPECIFICATION**

# **ELECTRICAL**

Electrical life: 2000 operation cycles per switch 24VDC, 25mA. Non-Switching Rating: 100mA, 50 VDC Switching Rating: 25mA, 24VCD.

Contact resistance: (a) 50mΩ max. at initial (b) 100mΩ max. after life test.

Insulation resistance: 100MΩ min. (at 500VDC)

Dielectric Strength: 500VAC/1 minute. Capacitance: 5pF max.

Circuit: Single pole single throw.

## MECHANICAL

Mechanical life: 2000 operations per cycle switch

Operation Force: 800gf max. Stroke: 2.0mm

Operation Temp: -25° C to +70° C

Storage Temp: -40° C to +85° C Vibration Test: MIL-STD-202F METHOD 201A Frequency: 10-55-10Hz/1 min Directions: X, Y, Z, three mutually

perpendicular directions. Time: 2 hours each direction. High reliability.

Shock Test: MIL-STD-202F METHOD 213B. CONDITION A

GRAVITY: 50G (peak value), 11 m/sec. Direction and times: 6 sides and three times in each direction. High reliability.

## SOLDERING AND CLEANING PROCESSES

For best results, please follow these recommendations: Keep all

switch contacts in their "OFF" position for all operations. WAVE SOLDERING: Recommended solder temperature at 500 F

(260 C) max. 5 seconds.

HAND SOLDERING: Use a soldering iron of 30 watts, controlled at 608 F(320° C)

approximately 2 seconds while applying solder. CLEANING PROCESS: Flux clean using force rinse, high agitation or triple bath cleaning method.

Freon TF or TE give excellent results. When vapor methods are used, do not subject the switch to solvents at

temperatures above 125 F (51° C).